

10/522983

APPLICATION DATA SHEET

DT05 Rec'd PCT/PTO 02 FEB 2005

Electronic Version v14

Stylesheet Version v14.1

*Applicant Information:*Inventor 1:

Applicant Authority Type: Inventor
Citizenship: JP
Given Name: Shigeyuki
Family Name: KOITO
City of Residence: Adachi-ku, Tokyo
Country of Residence: JP
Address-1 of Mailing Address: c/o Namiki Seimitsu Houseki Kabushiki Kaisha
Address-2 of Mailing Address: 8-22, Shinden 3-chome
City of Mailing Address: Adachi-ku, Tokyo
State of Mailing Address:
Postal Code of Mailing Address: 123-8511
Country of Mailing Address: JP
Phone:
Fax:
E-mail:

Correspondence Information:

Customer Number: 22204 *22204*

Application Information:

Title of Invention: LASER MACHINING METHOD
Application Type: regular, utility
Attorney Docket Number: 740675-59

Botanic Information:

Publication Information:

Suggested Figure for Publication -
Suggested Classification -
Suggested Technology Center -
Total Number of Drawing Sheets -

Representative Information:

practitioner(s) at Customer Number:

22204

22204

as my attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

Domestic Priority Information:

This is a National Stage of JP application number PCT/JP2003/009896, filed 2003-08-04, now PENDING.

Foreign Priority Information:

Doc.No:2002-228311; Country - JP; Date: 2002-08-06 us-priority-claimed

Assignee Information:

Assignee 1:

Organization Name: Namiki Seimitsu Houseki Kabushiki Kaisha

Address-1 of Mailing Address: 8-22, Shinden 3-chome

Address-2 of Mailing Address:

City of Mailing Address: Adachi-ku, Tokyo

State of Mailing Address:

Postal Code of Mailing Address: 123-8511

Country of Mailing Address: JP

Phone:

Fax:

E-mail:

